BF959

VHF Transistor

NPN Silicon

Features

• Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Collector - Emitter Voltage	V _{CEO}	20	Vdc	
Collector - Base Voltage	V _{CBO}	30	Vdc	
Emitter-Base Voltage	V _{EBO}	3.0	Vdc	
Collector Current – Continuous	I _C	100	mAdc	
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	625 5.0	mW mW/°C	
Total Device Dissipation P _D @ T _C = 25°C Derate above 25°C		1.5 12	W mW/°C	
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C	

THERMAL CHARACTERISTICS

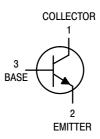
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



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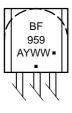
http://onsemi.com



MARKING DIAGRAM



TO-92 CASE 29 STYLE 21



BF959 = Device Code A = Assembly Location

Y = Year
WW = Work Week

Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
BF959	TO-92	5000 Units/Box
BF959G	TO-92 (Pb-Free)	5000 Units/Box
BF959RL1	TO-92	2000/Tape & Reel
BF959RL1G	TO-92 (Pb-Free)	2000/Tape & Reel
BF959ZL1	TO-92	2000/Ammo Pack
BF959ZL1G	TO-92 (Pb-Free)	2000/Ammo Pack

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Collector – Emitter Breakdown Voltage (I _C = 1.0 mAdc, I _B = 0)	V _{(BR)CEO}	20	_	_	Vdc	
Collector – Base Breakdown Voltage (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	30	-	-	Vdc	
Emitter – Base Breakdown Voltage ($I_E = 10 \mu Adc, I_C = 0$)	V _{(BR)EBO}	3.0	-	-	Vdc	
Collector Cutoff Current (V _{CB} = 20 Vdc, I _E = 0)	I _{CBO}	-	_	100	nAdc	
ON CHARACTERISTICS						
DC Current Gain ($I_C = 5.0 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$) ($I_C = 20 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$)	h _{FE}	35 40	- -	_ _	_	
Collector – Emitter Saturation Voltage (I _C = 30 mAdc, I _B = 2.0 mAdc)	V _{CE(sat)}	-	-	1.0	Vdc	
Base – Emitter Saturation Voltage (I _C = 30 mAdc, I _B = 2.0 mAdc)	V _{BE(sat)}	-	-	1.0	Vdc	
SMALL-SIGNAL CHARACTERISTICS						
$\begin{aligned} & \text{Current-Gain - Bandwidth Product} \\ & \text{(I}_{\text{C}} = 20 \text{ mAdc, V}_{\text{CE}} = 10 \text{ Vdc, f} = 100 \text{ MHz)} \\ & \text{(I}_{\text{C}} = 30 \text{ mAdc, V}_{\text{CE}} = 10 \text{ Vdc, f} = 100 \text{ MHz)} \end{aligned}$	f _T	700 600	- -	_ _	MHz	
Common Emitter Feedback Capacitance (V _{CB} = 10 Vdc, P _f = 0, f = 10 MHz)	C _{re}	-	0.65	_	pF	
Noise Figure (I _C = 4.0 mA, V_{CE} = 10 V, R_{S} = 50 Ω , f = 200 MHz)	N _f	-	3.0	_	dB	

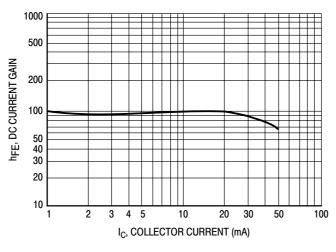


Figure 1. h_{FE} at 10 V

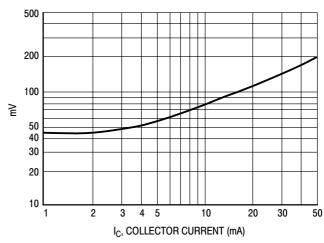


Figure 2. $V_{CE(sat)}$ at $I_C/I_B = 10$

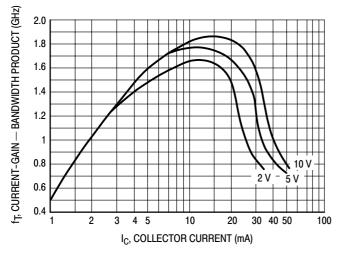


Figure 3. Current-Gain - Bandwidth Product

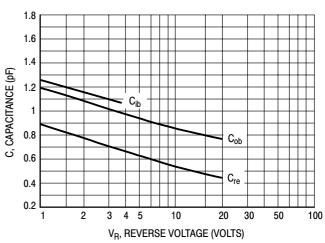


Figure 4. Capacitances

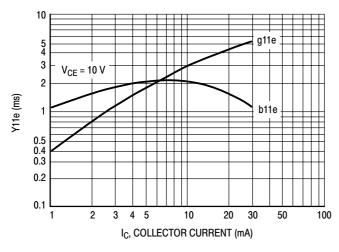


Figure 5. Input Impedance at 30 MHz

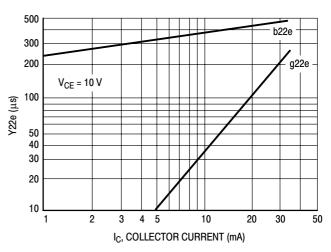
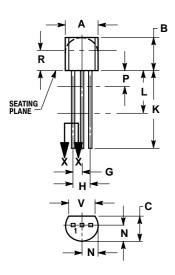


Figure 6. Output Impedance at 30 MHz

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PACKAGE DIMENSIONS

TO-92 TO-226AACASE 29-11
ISSUE AL





NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 MARKATAN AND TOLERANCING PER ANSI
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
- CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	METERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
P		0.100		2.54	
R	0.115		2.93		
٧	0.135		3.43		

STYLE 21:

PIN 1. COLLECTOR 2. EMITTER

3. BASE

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